#### SPIRE-RAL-MOM-002959

Telecon minutes. SMEC Launch Power Unit 29/08/07

Attendance: Doug Griffin Kevin Goodey Karine Mercier Dominique Pouliquen Guy Doubrovik, Bob Hibberd, Jurgen Lang Carsten Scharmberg Jan Rautokoski Matt Griffin (part time) Siegmund Idler Axel Koppe Eric Sawyer Christophe Cara Jean Fontignie Henri Triou <mark>Yvan Blanc</mark> Phillipe Clavel Jean Louis Augerres

# Actions from design review and previous telecons.

### **Today's Updates in Red**

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Exact location of heat source in the model.	RAL	Node 806 in the
Node number. To be supplied to Alcatel.		interface model.
		Node 3200 in the
		DTMM.
Astrium to inform SPIRE and ESA if any	Astrium	Closed ref e-mail. From Axel
information is missing, that may be preventing		20/7/07.
the start of harness manufacture		Connectors are being traced.
		Now been located at Thales and
		will be sent to Astrium.
RAL to manufacture shorting plug.	RAL	30/7/07
		in manufacture. Short plug is
		ready and will be hand carried
		to Astrium next week. Action
		can be closed
Generate an RFW to omit a shock test.	LAM/CNES	Open, discussed with ESTEC,
		an RFW will be written later but
		verbal agreement has been given
		dependant on orientation of
		relays. The chosen relays are
		robust.
		Experts at ESA have been
		contacted and discussion is
		continuing, agreement in
		principal.
		12/09 still in progress.
		12/09 still in progress.

		Technical discussion ongoing between ESTEC and CNES. Ared is in copy of the emails. There is no shock test on the FM Spacecraft
Produce the analysis of the predicted temperature when switched on.	LAM	Circulated on 19/7/07
New interface document to be issued	LAM	Circulated on 19/7/07
Arrange a visit by LAM to Astrium before bonding	LAM/Astrium	Open, not before September To be arranged next week 12/09: SVM is now closed, so we have lost this opportunity!! The next opening will be ~ 1 week prior to LPU integration. The cryoharness will have to be modified

Actions from 19/7/07 telecon				
Drawing showing assembly of components in the box to be produced.	LAM	Electrical design doc sent to Astrium. Including a 3D CAD drawing for review. Electrical design document LAM.PJT.SPI.SPT.070724_01 Issue 1 Rev 1 Sent on 26/7/07 No response from Astrium. Action closed		
Investigate if a structural analysis can be done at CEA.	CEA	Closed ref e-mail 25/7/07 from Jean-Louis. A hand calculation has been performed that indicates little effect on the FCU boards. A document N070730_CEA_FCU-LPU Modal analysis, was distributed on 30/7/07 by CEA		
Confirm the earliest start date for the wiring	LAM	Earliest date for QM is 16/8/07, early September for FM. Action closed		
Supply to Alcatel, scheme, parts list and data sheets,	LAM	24/7/07 circulated by Dominique immediately after this telecon. Action closed		
Give formal go ahead to Astrium for removal of anodise	RAL	Closed ref e-mail 19/7/07 from Eric, response received from Axel 20/7/07		

## Actions from 12/09/07 telecon

Get feedback from ASED on the	Axel	
compatibility of the LPU and spacecraft		
AIT activities		
Circulate LPU integration procedure for	Dominique	
comment		
Circulate electrical integration	Doug	
procedure for comment		

## **Dominique update:**

- Have glued QM onto the mech I/F last week
- LAM is allowing one week for cure
- Vibe tomorrow
- Thermal vac next week for cycling
- The internal harnesses for FM have been delivered
- FM Harness integration will happen next week
- Acceptance vibe next week
- FM Thermal vac the week after this
- In theory it should be deliverable CW 41 (starting 8/10/07) !
- $\bullet$  DRB provisionally booked to be held at LAM 8/10/07 13:00 start to allow for morning travel
- Document status (Gerard is on the case) first documents to be issued next week
- Email sent last week to Axel regarding abrading and gluing operations
  - The abrading needs to happen immediately prior to gluing to prevent build-up of an oxide layer.
- Action on Axel to coordinate LPU integration activities with ASED (tomorrow)

• Gluing procedure to be circulated at the end of this week. (LAM materials listed) Dominiques procedure finishes with the bonding strap verification

- DKG to circulate the electrical one
- Tentative DRB date 8/10/07 13:00 start
- RAL to provide the details for the ftp site for the DRB documentation

• EIDP mainly complete the end of next week. The test results will be available at the time of the review

## Next Telecon

• 28<sup>th</sup> Sept. same 14:00UK:15:00CET (Carsten may have to chair if Eric and Doug are not available)